

Product / Process Change Notification



N° 2016-052-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Introduction of additional lead plating supplier for SOT packages and additional wafer test location

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **28. March 2017**.
- Infineon aligns with the widely-recognized JEDEC STANDARD “**JESD46**“, which stipulates:
“**Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change.**”

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
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Chairman of the Supervisory Board: Wolfgang Mayrhuber
Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck
Registered Office: Neubiberg Commercial Register
Amtsgericht München HRB 126492

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► Products affected:

Please refer to affected product list 1_cip16052_a

- Wafer Test Transfer: see “Plating affected products”
- Lead Plating Supplier: see “Wafer Test affected products”

► Detailed Change Information:

Subject: Introduction of additional lead plating supplier for SOT packages and additional wafer test location

Reason: Expansion of wafer test and lead plating capacity.
Due to continuously raising demand for Infineon products, we are implementing wafer test facility in Infineon Kulim as additional wafer test location and WELNEW plating supplier as additional new lead plating supplier to assure continuity of supply and enable flexible manufacturing.

Description:

	<u>Old</u>	<u>New</u>
Wafer test location	<ul style="list-style-type: none">■ Infineon Technologies Austria AG, Villach, Austria	<ul style="list-style-type: none">■ Infineon Technologies (Kulim) Sdn. Bhd, Malaysia or■ Infineon Technologies Austria AG, Villach, Austria
Lead Plating Supplier	<ul style="list-style-type: none">■ TECHNIC plating supplier, Suzhou, China	<ul style="list-style-type: none">■ TECHNIC plating supplier, Suzhou, China or■ WELNEW plating supplier, Wuxi, China

► Product Identification:

Traceability assured via internal part number. No change in SP ordering number.

► Impact of Change:

Based on the qualification performed, Infineon does not see any negative impact on quality, function and reliability. No impact on fit and form.

► Attachments:

Affected product list 1_cip16052_a

► Time Schedule:

- Final qualification report: available
- First samples available: on request
- Intended start of delivery: 01-June-2017 or earlier after customer release

If you have any questions, please do not hesitate to contact your local Sales office.